





Features

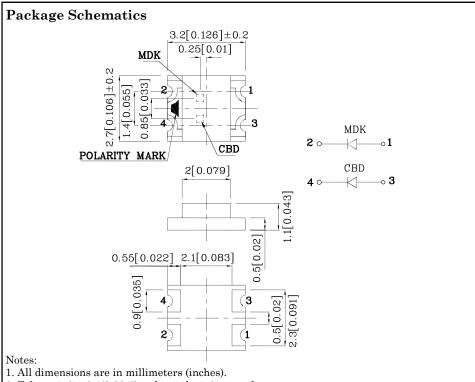
- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ullet Package : 2000 pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A =25°C)		MDK (AlGaInP)	CBD (InGaN)	Unit
Reverse Voltage	V_{R}	5	5	V
Forward Current	I_{F}	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	150	mA
Power Dissipation	P_D	75	120	mW
Electrostatic Discharge Threshold (HBM)		-	250	V
Operating Temperature	$T_{\rm A}$	-40 ~ + 85		°C
Storage Temperature	Tstg	-40 ~ +85		

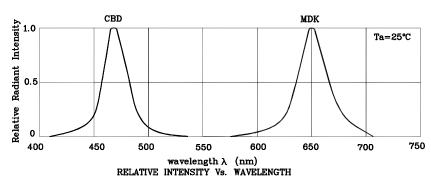
Operating Characteristics $(T_A=25^{\circ}C)$		MDK (AlGaInP)	CBD (InGaN)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	1.95	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	4	V
Reverse Current (Max.) $(V_R=5V)$	I_R	10	50	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	650	468	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	630	470	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	28	25	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	100	pF

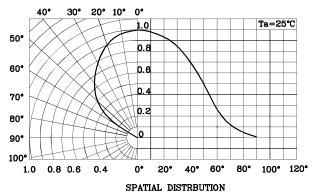
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} Luminous\\ Intensity\\ (I_F=20mA)\\ mcd \end{array}$		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMDKCBD98W	Red	AlGaInP	Water Class	120	248	650	100°
	Blue	InGaN	Water Clear -	55	98	468	

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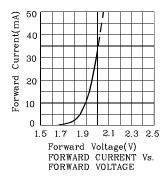


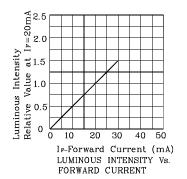


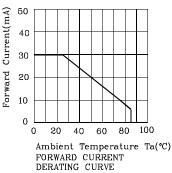


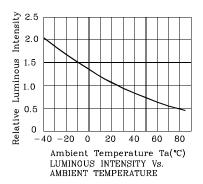


❖ MDK

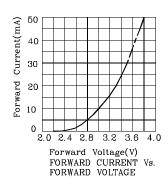


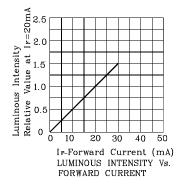


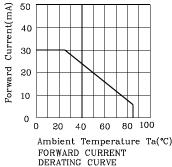


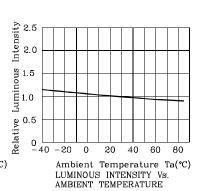


♦ CBD









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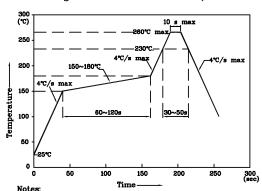
3.2x2.7mm SURFACE MOUNT LED LAMP



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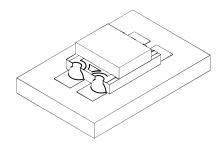
LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

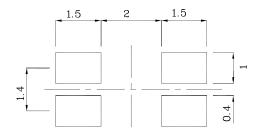


- Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions

❖ The device has a single mounting surface. The device must be mounted according to the specifications.



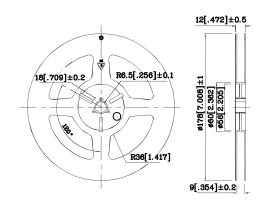
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Tape Specification (Units:mm)

TAPE $4\!\pm\!0.1$ 75±0. 0.2 ± 0.1 2 ± 0.1 4 ± 0.1 01.55 ± 0.1 $.3 \pm 0.1$ 05 8.15 ± 0.3 .5±0.

❖ Reel Dimension



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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PACKING & LABEL SPECIFICATIONS

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